

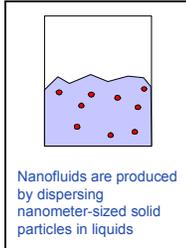
Enhanced Thermal Conductivity in Nanofluids

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Motivation

- Fluids typically have lower thermal conductivity (k) than most solids

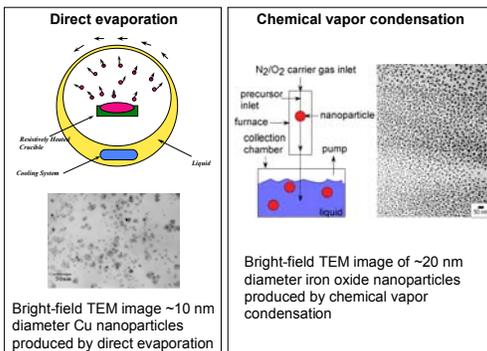
Material	Room Temperature Thermal Conductivity (W/m-K)
Metallic Solids:	
Silver	429
Copper	401
Aluminum	237
Nonmetallic Solids:	
Diamond	3300
Silicon	148
Alumina (Al ₂ O ₃)	40
Metallic Liquids:	
Sodium @ 844K	72.3
Nonmetallic Liq. (H₂O):	0.16



- Goal is to enhance effective fluid thermal conductivity and heat transfer coefficient by suspending solid nanoparticles
- Nanoparticles provide advantages due to better dispersion behavior, less clogging and abrasion, and much larger total surface area

Synthesis Techniques

- We produce nanofluids by 3 techniques:
 - direct evaporation
 - gas-condensation powder synthesis/dispersion
 - chemical vapor condensation
- Materials investigated to-date:
 - particles (Cu, Al₂O₃, CuO)
 - fluids (water, ethylene glycol, oil)

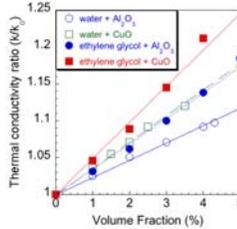


J. A. Eastman et al., *Appl. Phys. Lett.*, **78**, 718 (2001)

Measured Thermal Conductivity Enhancements

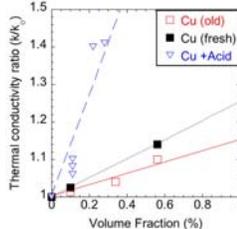
- Nanofluid thermal conductivity is measured by either the transient hot-wire or 3Ω technique

Oxide Nanoparticles



- ~20% increase in k seen for 4% CuO in ethylene glycol
- Larger improvement for CuO than Al₂O₃ is surprising

Copper Nanoparticles

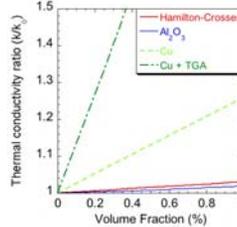
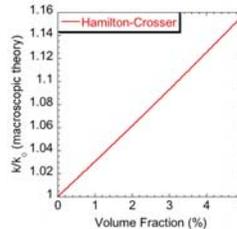


- 10 nm diameter Cu nanoparticles produce much larger increase in k than 30 nm diameter oxide nanoparticles
- thioglycolic acid improves dispersion behavior (but adding acid alone does not affect k)

Comparison With Theory

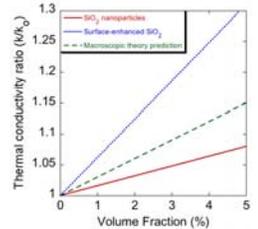
$$\frac{k}{k_o} \approx \frac{1+2V_p}{1-V_p} \quad \text{R. Hamilton and O. Crosser, I&EC Fundamentals, 1, 187 (1962)}$$

- Hamilton and Crosser's macroscopic theory predicts that the increase in conductivity in nanofluids is independent of particle size and particle conductivity
- Our oxide data is in reasonable agreement with Hamilton-Crosser predictions
- However, Cu data shows much larger than expected increase in conductivity (macroscopic theory is not sufficient to explain the behavior of nanofluids)



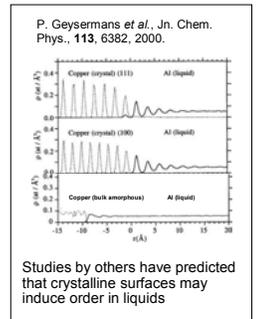
Importance of Surface Treatment

- Nanofluids containing surface-modified SiO₂ nanoparticles exhibit large increases in thermal conductivity
- Similar strong improvements were observed when thioglycolic acid was added to copper nanofluids
- Future work will focus on determining surface treatments of nanoparticles



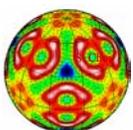
Possible Mechanisms

- The effects of several possible mechanisms for the improved heat transfer properties of nanofluids are being examined



Conclusions / Outlook

- Potential for applications:
 - Many industries would benefit from the enhanced heat transfer rates attainable by using nanofluids
- U.S. Choi and J.A. Eastman, "Enhanced Heat Transfer Using Nanofluids," *U.S. Patent #6,221,275*
- Future studies are needed:
 - heat transfer mechanism(s) not understood
 - optimal nanoparticle/fluid combination may depend on application
 - heat transfer depends on more than thermal conductivity (need to determine heat transfer behavior under fluid flow conditions)
 - ancillary properties may also be important (e.g., erosion, abrasion, corrosion, stability)



BES - DOE

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MSD - ANL

